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**AMENDMENTS TO THE CLAIMS** 

This listing of claims will replace all prior versions and listings of claims in the

application:

LISTING OF CLAIMS:

1. (currently amended): A negative resist composition comprising:

(A) an alkali-soluble resin;

(B-1) a cross-linking agent capable of cross-linking with the alkali-soluble resin (A) by

the action of an acid, in which the cross-linking agent is not a resin and is a phenol compound

containing: at least one phenolic hydroxyl group; one or more benzene rings in the molecule; and

at least two cross-linking groups bonded to any of the benzene rings, the cross-linking group

being a group selected from the group consisting of a hydroxymethyl group, an alkoxymethyl

group and an acyloxymethyl group;

(B-2) a cross-linking agent capable of cross-linking with the alkali-soluble resin (A) by

the action of an acid, in which the cross-linking agent contains at least two groups selected from

the group consisting of the groups represented by the following formulae (1) and (2): and

(C) a compound capable of generating an acid upon irradiation with an actinic ray or

radiation; and

(D) a nitrogen-containing basic compound:

N-CH<sub>2</sub>-O-R<sub>3</sub> (1)

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$$CH_2-O-R_4$$
 $-N$ 
 $CH_2-O-R_5$ 
(2)

wherein  $R_3$  represents a hydrogen atom, an alkyl group, or an alkylcarbonyl group; and  $R_4$  and  $R_5$  each represents a hydrogen atom, an alkyl group or an alkylcarbonyl group.

2. (previously presented): The negative resist composition as described in claim 1, wherein the alkali-soluble resin (A) contains a repeating unit represented by the following formula (3):

wherein A represents a hydrogen atom, an alkyl group, a halogen atom, or a cyano group; R<sub>1</sub> and R<sub>2</sub> each represents a hydrogen atom, a halogen atom, an alkyl group, an alkenyl group, a cycloalkyl group, an aryl group, an aralkyl group, an alkoxy group or an alkylcarbonyloxy group; and n represents an integer of 1 to 3.

Claim 3. (canceled).

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4. (previously presented): The negative resist composition as described in claim 1, wherein the alkali-soluble resin (A) contains at least one repeating unit selected from the group consisting of the repeating units represented by the following formulae (4), (5) and (6):

$$+CH_2-C$$
 $R_{15}$ 
 $R_{11}$ 
 $R_{12}$ 
 $R_{12}$ 
 $R_{13}$ 
 $R_{12}$ 
 $R_{13}$ 
 $R_{14}$ 

wherein represents a group selected from the group consisting of the following structures:

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A represents a hydrogen atom, an alkyl group, a halogen atom, or a cyano group; X is a single bond, -COO-, -O-, or -CON( $R_{16}$ )-;  $R_{16}$  represents a hydrogen atom, or an alkyl group;  $R_{11}$  to  $R_{15}$  each represents a hydrogen atom, a halogen atom, an alkyl group, an alkenyl group, a cycloalkyl group, an aryl group, an aralkyl group, an alkoxy group or an alkylcarbonyloxy group;  $R_{101}$  to  $R_{106}$  each represents a hydroxyl group, a halogen atom, an alkyl group, an alkoxy group, an alkylcarbonyloxy group, an aryl group, an aralkyl group, or a carboxyl group; and a to f each represents an integer of from 0 to 3.

- 5. (original): The negative resist composition as described in claim 1, which further contains a surfactant.
- 6. (original): The negative resist composition as described in claim 2, wherein the alkalisoluble resin (A) contains the repeating unit represented by the formula (3) in an amount of 50 to 100 mole %.

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7. (previously presented): The negative resist composition as described in claim 4, wherein the alkali-soluble resin (A) contains at least one repeating unit selected from the group consisting of the repeating units represented by the formulae (4), (5) and (6) in an amount of 3 to 50 mole %.

- 8. (previously presented): The negative resist composition as described in claim 1, wherein the cross-linking agent (B-1) is a phenol derivative having: a molecular weight of 2,000 or below; 3 to 5 benzene rings per molecule; and at least two cross-linking groups per molecule, in which the cross-linking group is a group selected from the group consisting of a hydroxymethyl group, an alkoxymethyl group and an acyloxymethyl group, and the cross-linking group is bonded to any of the benzene rings.
- 9. (previously presented): The negative resist composition as described in claim 1, wherein the cross-linking agent (B-1) is a phenol derivative having: 1 to 2 benzene rings per molecule; and at least two cross-linking groups per molecule, in which the cross-linking group is a group selected from the group consisting of a hydroxymethyl group, an alkoxymethyl group and an acyloxymethyl group, and the cross-linking group is bonded to any of the benzene rings.
- 10. (previously presented): The negative resist composition as described in claim 1, wherein the cross-linking agent (B-2) represents one of a compound or resin containing a

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melamine skeleton, a compound or resin containing a urea skeleton, a compound or resin containing an imidazolidine skeleton, and a compound or resin containing a glycoluril skeleton.

11. (original): The negative resist composition as described in claim 1, which comprises the cross-linking agent (B-1) in a proportion of 0.5 to 50 % by weight, to the total solid content in the negative resist composition.

12. (original): The negative resist composition as described in claim 1, which comprises the cross-linking agent (B-2) in a proportion of 0.5 to 50 % by weight, to the total solid content in the negative resist composition.

- 13. (original): The negative resist composition as described in claim 1, wherein the ratio between the cross-linking agents (B-1) and (B-2) is from 3/97 to 97/3 by mole.
- 14. (original): A method of forming a resist pattern, which comprises: forming a resist film including the negative resist composition described in claim 1; irradiating the resist film with an actinic ray or radiation; and developing the irradiated resist film.
- 15. (new): The negative resist composition as described in claim 1, wherein the nitrogen-containing basic compound (D) includes a structure represented by one of the following

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formulae (A), (B), (C), (D) or (E), and in which formulae (B), (C), (D), or (E) each may be part of a cyclic structure:

$$R^{251}$$
 (A)
$$R^{250} - N - R^{252}$$

$$\begin{array}{c|c}
 & 1 \\
-N-C=N-
\end{array}$$

$$= \stackrel{!}{C} - \mathcal{N} = \stackrel{!}{C} - \tag{C}$$

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$$R^{254}$$
  $R^{255}$   
 $R^{253}$   $C$   $N$   $C$   $R^{256}$  (E)

wherein R<sup>250</sup>, R<sup>251</sup> and R<sup>252</sup>, which may be the same or different, each represents a hydrogen atom, a 1-6C alkyl group, a 1-6C aminoalkyl group, a 1-6C hydroxyalkyl group, or a 6-20 C substituted or unsubstituted aryl group, and wherein R<sup>251</sup> and R<sup>252</sup> may combine to form a ring, and wherein R<sup>253</sup>, R<sup>254</sup>, R<sup>255</sup> and R<sup>256</sup> each represents a same or different 1-6C alkyl group.

16. (new): The negative resist composition as described in claim 1, wherein the molar ratio of acid generator compound (C) to nitrogen-containing basic compound (D) is 2.5 to 300.

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17. (new): The negative resist composition as described in claim 1, wherein the molar ratio of acid generator compound (C) to nitrogen-containing basic compound (D) is 5.0 to 200.

18. (new): The negative resist composition as described in claim 1, wherein the molar ratio of acid generator compound (C) to nitrogen-containing basic compound (D) is 7.0 to 150.

19. (new): The negative resist composition as described in claim 1, wherein the molecular weight of the alkali-soluble resin (A), on weight average, is from 1,000 to 200,000.

20. (new): The negative resist composition as described in claim 1, wherein the molecular weight of the alkali-soluble resin (A), on weight average, is from 2,000 to 50,000.